# MA2B170, MA2B171 (MA170, MA171)

# Silicon epitaxial planar type

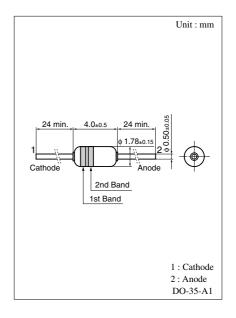
For high-speed switching circuits

#### ■ Features

- $\bullet$  Large forward current  $I_{F(AV)}$
- High switching speed
- Small terminal capacitance, C<sub>t</sub>

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage	MA2B170	$V_R$	40	V
(DC)	MA2B171		80	
Repetitive peak	MA2B170	$V_{RRM}$	40	V
reverse voltage	MA2B171		80	
Average forward current		I <sub>F(AV)</sub>	200	mA
Repetitive peak forward current		$I_{FRM}$	600	mA
Non-repetitive peak		$I_{FSM}$	1	A
forward surge current*				
Junction temperature		$T_{j}$	200	°C
Storage temperature		$T_{stg}$	-55 to +200	°C



Note) \* : t = 1 s

## ■ Electrical Characteristics $T_a = 25$ °C

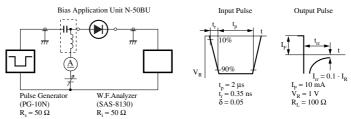
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	MA2B170	$I_{R1}$	$V_R = 15 \text{ V}$			50	nA
	MA2B171						
	MA2B170	$I_{R2}$	$V_R = 35 \text{ V}$			500	nA
	MA2B171		V <sub>R</sub> = 75 V			500	
	MA2B170	$I_R$	$V_R = 35 \text{ V}, T_a = 150^{\circ}\text{C}$			100	μΑ
	MA2B171		$V_R = 75 \text{ V}, T_a = 150^{\circ}\text{C}$			100	
Forward voltage (DC)		$V_{\rm F}$	$I_F = 200 \text{ mA}$			1.1	V
Terminal capacitance		C <sub>t</sub>	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$			4	pF
Reverse recovery time*		t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 1 \text{ V}$			20	ns
			$I_{rr} = 0.1 \cdot I_R, R_L = 100 \Omega$				

Note) 1. Rated input/output frequency: 100 MHz

#### ■ Cathode Indication

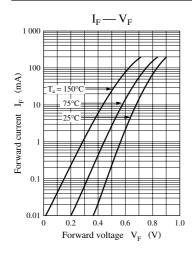
Type No.		MA2B170	MA2B171		
Color	1st Band	Violet	Violet		
	2nd Band	White	Green		

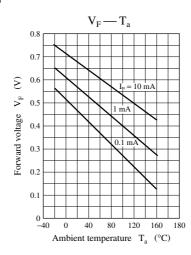
2. \*: t<sub>rr</sub> measuring circuit

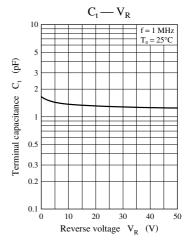


Note) The part numbers in the parenthesis show conventional part number.

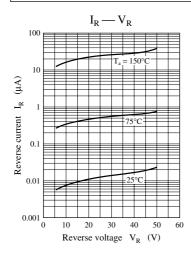
#### Common characteristics charts

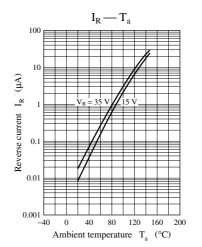




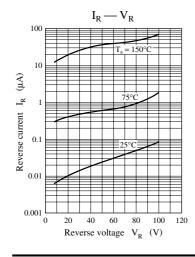


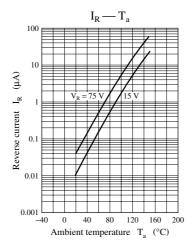
#### Characteristics charts of MA2B170





# Characteristics charts of MA2B171





Panasonic 175

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